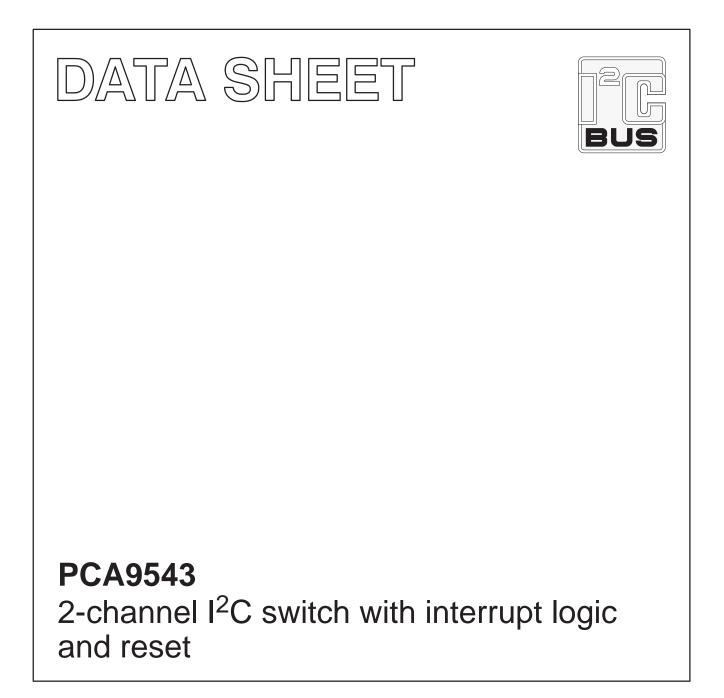
INTEGRATED CIRCUITS



Product data

2002 Feb 19

File under Integrated Circuit — ICL03



PCA9543



FEATURES

- 1-of-2 bi-directional translating switches
- I²C interface logic; compatible with SMBus standards
- 2 Active Low Interrupt Inputs
- Active Low Interrupt Output
- Active Low Reset Input
- 2 address pins allowing up to 4 devices on the I²C bus
- Channel selection via I²C bus, in any combination
- Power up with all switch channels deselected
- Low Rds_{ON} switches
- Allows voltage level translation between 1.8 V, 2.5 V, 3.3 V and 5 V buses
- No glitch on power-up
- Supports hot insertion
- Low stand-by current
- Operating power supply voltage range of 2.3 V to 5.5 V
- 5 V tolerant Inputs
- 0 to 400 kHz clock frequency
- ESD protection exceeds 2000 V HBM per JESD22-A114, 150 V MM per JESD22-A115 and 1000 V per JESD22-C101
- Latchup testing is done to JESDEC Standard JESD78 which exceeds 100 mA
- Package Offer: SO14, TSSOP14

DESCRIPTION

The PCA9543 is a bi-directional translating switch, controlled by the I²C bus. The SCL/SDA upstream pair fans out to two downstream pairs, or channels. Any individual SCx/SDx channels or combination of channels can be selected, determined by the contents of the programmable control register. Two interrupt inputs, INTO to INT3, one for each of the downstream pairs, are provided. One interrupt output INT, which acts as an AND of the two interrupt inputs, is provided.

An active-LOW reset input allows the PCA9543 to recover from a situation where one of the downstream I²C buses is stuck in a LOW state. Pulling the RESET pin LOW resets the I²C state machine and causes all the channels to be deselected, as does the internal power on reset function.

The pass gates of the switches are constructed such that the V_{DD} pin can be used to limit the maximum high voltage which will be passed by the PCA9543. This allows the use of different bus voltages on each SCx/SDx pair, so that 1.8 V, 2.5 V, or 3.3 V parts can communicate with 5 V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5 V tolerant.

PIN CONFIGURATION

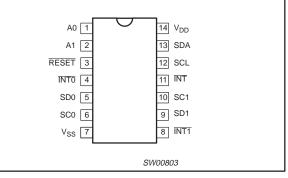


Figure 1. Pin configuration

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	A0	Address input 0
2	A1	Address input 1
3	RESET	Active LOW reset input
4	INTO	Interrupt input 0
5	SD0	Serial data 0
6	SC0	Serial clock 0
7	V _{SS}	Supply ground
8	INT1	Interrupt input 1
9	SD1	Serial data 1
10	SC1	Serial clock 1
11	ĪNT	Interrupt output
12	SCL	Serial clock line
13	SDA	Serial data line
14	V _{DD}	Supply voltage

ORDERING INFORMATION

PACKAGES	PACKAGES TEMPERATURE RANGE		DRAWING NUMBER
14-Pin Plastic SO	–40 to +85 °C	PCA9543D	SOT108-1
14-Pin Plastic TSSOP	–40 to +85 °C	PCA9543PW	SOT402-1

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

BLOCK DIAGRAM

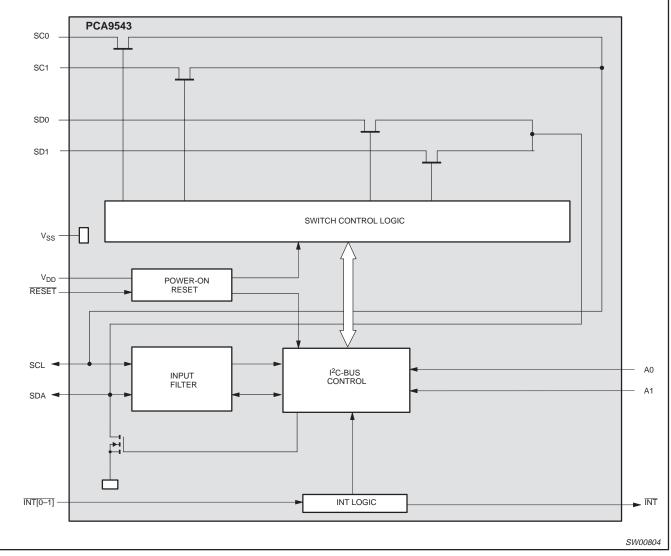


Figure 2. Block diagram

Product data

PCA9543

DEVICE ADDRESS

Following a START condition the bus master must output the address of the slave it is accessing. The address of the PCA9543 is shown in Figure 3. To conserve power, no internal pullup resistors are incorporated on the hardware selectable address pins and they must be pulled HIGH or LOW.

1	1 1	0	0	A1	A0	R/W				
	FIXE	D	HA	ARDV	VARE	, Sele	ЕСТА	BLE	SW0089	13

Figure 3. Slave address

The last bit of the slave address defines the operation to be performed. When set to logic 1, a read is selected while a logic 0 selects a write operation.

CONTROL REGISTER

Following the successful acknowledgement of the slave address, the bus master will send a byte to the PCA9543, which will be stored in the control register. If multiple bytes are received by the PCA9543, it will save the last byte received. This register can be written and read via the I^2C bus.

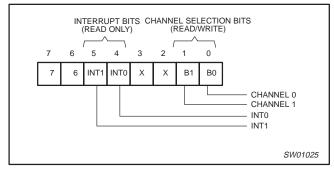


Figure 4. Control Register

CONTROL REGISTER DEFINITION

One or several SCx/SDx downstream pair, or channel, is selected by the contents of the control register. This register is written after the PCA9543 has been addressed. The 2 LSBs of the control byte are used to determine which channel is to be selected. When a channel is selected, the channel will become active after a stop condition has been placed on the I²C bus. This ensures that all SCx/SDx lines will be in a HIGH state when the channel is made active, so that no false conditions are generated at the time of connection.

Table 1.	Control Register; Write — Channel Selection/
Read —	Channel Status

D7	D6	INT1	INT0	D3	D2	B1	B0	COMMAND
x	x	x	x	x	x	x	0	Channel 0 disabled
	~		~	~	^	~	1	Channel 0 enabled
x	x	x	x	x	x	0	x	Channel 1 disabled
	X			X	~	1	X	Channel 1 enabled

NOTE: Channel 0 and 1 can be enabled at the same time. Care should be taken not to exceed the maximum bus capacitance.

INTERRUPT HANDLING

The PCA9543 provides 2 interrupt inputs, one for each channel, and one open drain interrupt output. When an interrupt is generated by any device, it will be detected by the PCA9543 and the interrupt output will be driven LOW. The channel need not be active for detection of the interrupt. A bit is also set in the Control Register.

Bits 4 – 5 of the Control Register correspond to the INT0 and INT1 inputs of the PCA9543, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The master can then address the PCA9543 and read the contents of the Control Register to determine which channel contains the device generating the interrupt. The master can then reconfigure the PCA9543 to select this channel, and locate the device generating the interrupt and clear it.

It should be noted that more than one device can be providing an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

The interrupt inputs may be used as general purpose inputs if the interrupt feature is not required.

If unused, interrupt input(s) must be connected to $\mathsf{V}_{\mathsf{D}\mathsf{D}}$ through a pull-up resistor.

7	6	INT1	INT0	3	2	B1	B0	COMMAND
x	x	x	0	Y	v	v	х	No interrupt on channel 0
		^	1			^	~	Interrupt on channel 0
x	x	0	x	x	x	x	х	No interrupt on channel 1
	^	1	^	^	~	~	~	Interrupt on channel 1

Table 2. Control Register Read — Interrupt

NOTE: The two interrupts can be active at the same time.

RESET INPUT

The RESET input is an active-LOW signal which may be used to recover from a bus fault condition. By asserting this signal LOW for a minimum of t_{WL} , the PCA9543 will reset its registers and I^2C state machine and will deselect all channels. The RESET input must be connected to V_{DD} through a pull-up resistor.

POWER-ON RESET

When power is applied to V_{DD}, an internal Power On Reset holds the PCA9543 in a reset state until V_{DD} has reached V_{POR}. At this point, the reset condition is released and the PCA9543 registers and I²C state machine are initialized to their default states, all zeroes causing all the channels to be deselected.

VOLTAGE TRANSLATION

The pass gate transistors of the PCA9543 are constructed such that the V_{DD} voltage can be used to limit the maximum voltage that will be passed from one I²C bus to another.

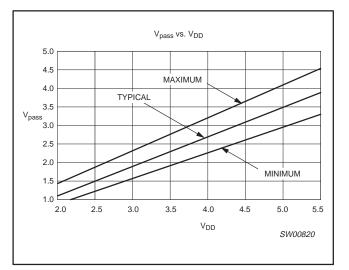


Figure 5. V_{pass} voltage

Figure 5 shows the voltage characteristics of the pass gate transistors (note that the graph was generated using the data specified in the DC Characteristics section of this datasheet). In order for the PCA9543 to act as a voltage translator, the V_{pass} voltage should be equal to, or lower than the lowest bus voltage. For example, if the main bus was running at 5 V, and the downstream buses were 3.3 V and 2.7 V, then V_{pass} should be equal to or below 2.7 V to effectively clamp the downstream bus voltages. Looking at Figure 5, we see that V_{pass} (max.) will be at 2.7 V when the PCA9543 supply voltage is 3.5 V or lower so the PCA9543 supply voltage could be set to 3.3 V. Pull-up resistors can then be used to bring the bus voltages to their appropriate levels (see Figure 12).

More Information can be found in Application Note AN262 PCA954X family of $l^2C/SMBus$ multiplexers and switches.

PCA9543

2-channel I²C switch with interrupt logic and reset

CHARACTERISTICS OF THE I²C-BUS

The I²C-bus is for 2-way, 2-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as control signals (see Figure 6).

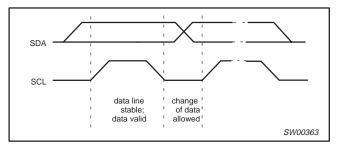


Figure 6. Bit transfer

Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P) (see Figure 7).

System configuration

A device generating a message is a transmitter: a device receiving is the receiver. The device that controls the message is the master and the devices which are controlled by the master are the slaves (see Figure 8).

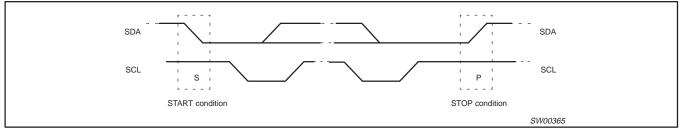


Figure 7. Definition of start and stop conditions

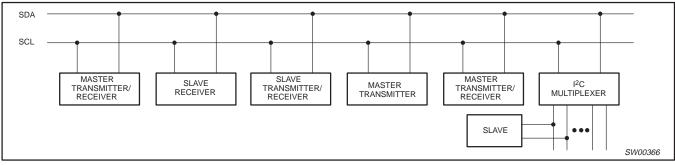


Figure 8. System configuration

PCA9543

Acknowledge

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse, set-up and hold times must be taken into account.

A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event, the transmitter must leave the data line HIGH to enable the master to generate a stop condition.

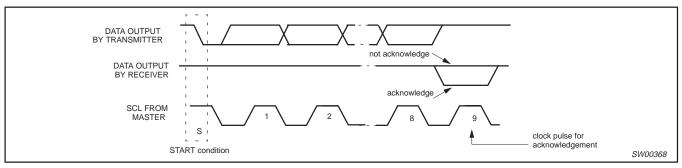


Figure 9. Acknowledgement on the I²C-bus

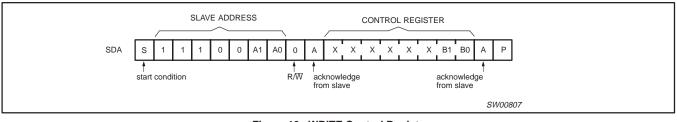


Figure 10. WRITE Control Register

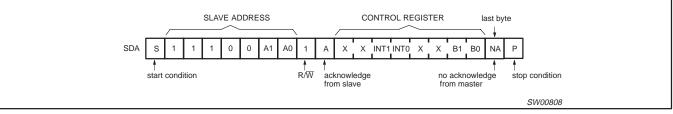
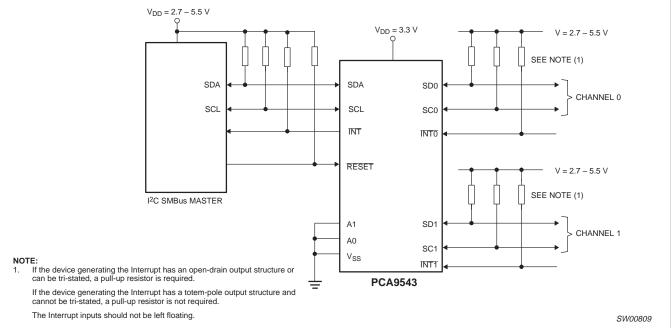


Figure 11. READ Control Register

TYPICAL APPLICATION





PCA9543

PCA9543

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{DD}	DC supply voltage		-0.5 to +7.0	V
VI	DC input voltage		-0.5 to +7.0	V
l _l	DC input current		±20	mA
Ι _Ο	DC output current		±25	mA
I _{DD}	Supply current		±100	mA
I _{SS}	Supply current		±100	mA
P _{tot}	total power dissipation		400	mW
T _{stg}	Storage temperature range		-60 to +150	°C
T _{amb}	Operating ambient temperature		-40 to +85	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

DC CHARACTERISTICS

 V_{DD} = 2.3 to 3.6 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified. (See page 10 for V_{DD} = 3.6 to 5.5 V)

SYMBOL	DADAMETER	TEST CONDITIONS		LIMITS	6		
STWBUL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX		
Supply	•	•					
V _{DD}	Supply voltage		2.3	—	3.6	V	
I _{DD}	Supply current	Operating mode; V_{DD} = 3.6 V; no load; V _I = V _{DD} or V _{SS} ; f _{SCL} = 100 kHz	-	160	200	μA	
I _{stb}	Standby current	Standby mode; V_{DD} = 3.6 V; no load; V_{I} = V_{DD} or V_{SS} ; f_{SCL} = 0 kHz	-	25	100	μA	
V _{POR}	Power-on reset voltage	no load; V _I = V _{DD} or V _{SS}	-	1.6	2.1	V	
Input SCL; inpu	ut/output SDA	•	•				
V _{IL}	LOW level input voltage		-0.5	I —	0.3 V _{DD}	V	
V _{IH}	HIGH level input voltage		0.7 V _{DD}	<u> </u>	6	V	
	LOW level output current	V _{OL} = 0.4 V	3	<u> </u>	-	mA	
IOL	LOW level output current	V _{OL} = 0.6 V	6	<u> </u>	-		
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	<u> </u>	+1	μΑ	
Ci	Input capacitance	V _I = V _{SS}	-	9	10	pF	
Select inputs A	0 to A1 / INTO to INT1 / RESET	•	•				
V _{IL}	LOW level input voltage		-0.5	I —	+0.3 V _{DD}	V	
VIH	HIGH level input voltage		0.7 V _{DD}	<u> </u>	V _{DD} + 0.5	V	
ILI	Input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	<u> </u>	+1	μΑ	
Ci	Input capacitance	V _I = V _{SS}	- 1	1.6	3	pF	
Pass Gate	·	•					
P	Switch resistance	V_{CC} = 3.0 to 3.6 V, V_O = 0.4 V, I_O = 15 mA	5	20	30	Ω	
R _{ON}	Switch resistance	V_{CC} = 2.3 to 2.7 V, V_O = 0.4V, I_O = 10 mA	7	26	55	1 1	
		$V_{swin} = V_{DD} = 3.3 \text{ V}; I_{swout} = -100 \mu\text{A}$	- 1	2.2	—		
V	Switch output voltage	$V_{swin} = V_{DD} = 3.0$ to 3.6 V; $I_{swout} = -100 \ \mu A$	1.6	<u> </u>	2.8		
V _{Pass}	Switch output voltage	$V_{swin} = V_{DD} = 2.5 \text{ V}; I_{swout} = -100 \ \mu\text{A}$	- 1	1.5	-	1 [×]	
		$V_{swin} = V_{DD} = 2.5 \text{ to } 2.7 \text{ V}; I_{swout} = -100 \mu\text{A}$	1.1	<u> </u>	2.0	1	
١L	Leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	- 1	+1	μA	
C _{io}	Input/output capacitance	$V_I = V_{SS}$	- 1	3	5	pF	
NT Output	-	·	-		•	-	
I _{OL}	LOW level output current	V _{OL} = 0.4 V	3	- 1	—	mA	
I _{OH}	HIGH level output current		<u> </u>	<u> _ </u>	+100	μA	

2-channel I^2C switch with interrupt logic and reset

PCA9543

DC CHARACTERISTICS

 V_{DD} = 3.6 to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified. (See page 9 for V_{DD} = 2.3 to 3.6 V)

OVINDO	DADAMETED	TEAT CONDITIONS				
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	
Supply	-	•				
V _{DD}	Supply voltage		3.6	-	5.5	V
I _{DD}	Supply current	Operating mode; V_{DD} = 5.5 V; no load; V_I = V_{DD} or V_{SS} ; f_{SCL} = 100 kHz	_	570	600	μA
I _{stb}	Standby current	Standby mode; V_{DD} = 5.5 V; no load; V_I = V_{DD} or V_{SS} ; f_{SCL} = 0 kHz	_	80	200	μA
V _{POR}	Power-on reset voltage	no load; $V_I = V_{DD}$ or V_{SS}	—	1.7	2.1	V
Input SCL; inpu	ut/output SDA	-		-		
V _{IL}	LOW level input voltage		-0.5	-	0.3 V _{DD}	V
V _{IH}	HIGH level input voltage		0.3 V _{DD}	-	6	V
		V _{OL} = 0.4 V	3	-	—	mA
I _{OL}	LOW level output current	V _{OL} = 0.6 V	6	-	_	mA
IIL	LOW level input current	$V_{I} = V_{SS}$	-10	-	10	μΑ
I _{IH}	HIGH level input current	$V_{I} = V_{DD}$	—	-	100	μΑ
Ci	Input capacitance	$V_{I} = V_{SS}$	—	9	10	pF
Select inputs A	0 to A1 / INTO to INT1 / RESET	·				· · · ·
VIL	LOW level input voltage		-0.5	-	+0.3 V _{DD}	V
VIH	HIGH level input voltage		0.7 V _{DD}	- 1	V _{DD} + 0.5	V
I _{LI}	Input leakage current	$V_{I} = V_{DD} \text{ or } V_{SS}$	-1	—	+50	μA
Ci	Input capacitance	$V_{I} = V_{SS}$	—	2	5	pF
Pass Gate						
R _{ON}	Switch resistance	V_{CC} = 4.5 to 5.5 V, V_{O} = 0.4 V, I_{O} = 15 mA	4	11	24	Ω
M	Cuuitab autout valtara	$V_{swin} = V_{DD} = 5.0 \text{ V}; \text{ I}_{swout} = -100 \mu\text{A}$	—	3.5	—	V
V _{Pass}	Switch output voltage	$V_{swin} = V_{DD} = 4.5$ to 5.5 V; $I_{swout} = -100 \ \mu A$	2.6	-	4.5	V
١L	Leakage current	$V_I = V_{DD} \text{ or } V_{SS}$	-1	- 1	+100	μΑ
C _{io}	Input/output capacitance	$V_{I} = V_{SS}$	—	3	5	pF
INT Output						
I _{OL}	LOW level output current	V _{OL} = 0.4 V	3	_	—	mA
I _{OH}	HIGH level output current		—	—	+100	μΑ

AC CHARACTERISTICS

SYMBOL	PARAMETER		RD-MODE -BUS	FAST-MODE	I ² C-BUS	UNIT
		MIN	MAX	MIN	MAX	
t _{pd}	Propagation delay from SDA to SD _n or SCL to SC _n	_	0.3 ¹	—	0.3 ¹	ns
f _{SCL}	SCL clock frequency	0	100	0	400	kHz
t _{BUF}	Bus free time between a STOP and START condition	4.7	- 1	1.3		μs
t _{HD;STA}	Hold time (repeated) START condition After this period, the first clock pulse is generated	4.0	_	0.6	_	μs
t _{LOW}	LOW period of the SCL clock	4.7	- 1	1.3	-	μs
tHIGH	HIGH period of the SCL clock	4.0	—	0.6	-	μs
t _{SU;STA}	Set-up time for a repeated START condition	4.7	-	0.6	-	μs
t _{SU;STO}	Set-up time for STOP condition	4.0	-	0.6	—	μs
t _{HD;DAT}	Data hold time	0 ²	3.45	02	0.9	μs
t _{SU;DAT}	Data set-up time	250	-	100	—	ns
t _R	Rise time of both SDA and SCL signals	-	1000	$20 + 0.1 C_b^3$	300	ns
t _F	Fall time of both SDA and SCL signals	—	300	$20 + 0.1 C_b^3$	300	μs
Cb	Capacitive load for each bus line	—	400	—	400	μs
t _{SP}	Pulse width of spikes which must be suppressed by the input filter	—	50	—	50	ns
t _{VD:DATL}	Data valid (HL)		1	—	1	μs
t _{VD:DATH}	Data valid (LH)	_	0.6	—	0.6	μs
t _{VD:ACK}	Data valid Acknowledge	-	1	—	1	μs
INT						
t _{iv}	INTn to INT active valid time	-	4	—	4	μs
t _{ir}	INTn to INT inactive delay time		2	—	2	μs
L _{pwr}	LOW level pulse width rejection or INTn inputs	1	- 1	1	_	ns
H _{pwr}	HIGH level pulse width rejection or INTn inputs	500	- 1	500	_	ns
RESET						
t _{WL(rst)}	Pulse width low reset	4	- 1	4		ns
t _{rst}	Reset time (SDA clear)	500	- 1	500	_	ns
t _{REC:STA}	Recovery to Start	0	—	0		ns

NOTES:

Pass gate propagation delay is calculated from the 20 Ω typical R_{ON} and and the 15 pF load capacitance.
A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIH_{min} of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

3. C_b = total capacitance of one bus line in pF.

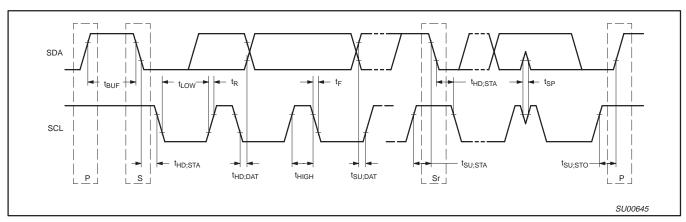


Figure 13. Definition of timing on the I²C-bus

Product data

PCA9543

SO14: plastic small outline package; 14 leads; body width 3.9 mm SOT108-1 А Х = v 🕅 A HE Q Ab pin 1 index Ш 出 Ħ Γ е + w M detail X bp 2.5 5 mm 0 scale DIMENSIONS (inch dimensions are derived from the original mm dimensions) А D⁽¹⁾ E⁽¹⁾ Z ⁽¹⁾ UNIT L Q θ v A₁ A_2 A_3 bp С е $H_{\rm E}$ Lp w У max. 0.25 1.45 0.49 0.25 8.75 4.0 6.2 1.0 0.7 0.7 1.05 mm 1.75 0.25 1.27 0.25 0.25 0.1 1.25 8.55 5.8 0.3 0.10 0.36 3.8 0.4 0.6 8° 0.19 00 0.010 0.057 0.019 0.0100 0.35 0.16 0.244 0.039 0.028 0.028 0.050 0.041 0.01 0.01 0.004 inches 0.069 0.01 0.014 0.0075 0.004 0.049 0.34 0.15 0.228 0.016 0.024 0.012 Note 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06	MS-012				-97-05-22 99-12-27	

12

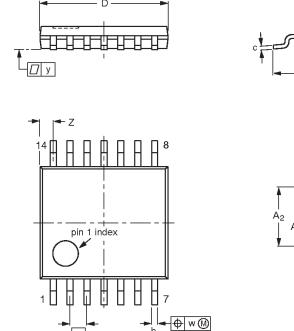
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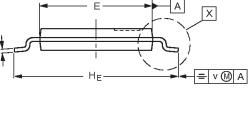
PCA9543

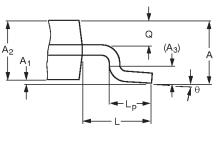
Product data

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm









detail X



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _р	с	D ⁽¹⁾	E ⁽²⁾	e	HE	L	Lp	Q	v	¥	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

е

2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT402-1		MO-153				-95-04-04 99-12-27

PCA9543

SOT402-1

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Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definitions	
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Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.	
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[1] Please consult the most recently issued data sheet before initiating or completing a design.

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Document order number:

Date of release: 02-02

9397 750 09458

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